

## N-Channel 60-V (D-S) MOSFET

### PRODUCT SUMMARY

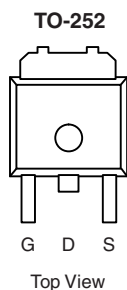
| $V_{DS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) <sup>a</sup> |
|--------------|---------------------------|------------------------|
| 60           | 0.025 at $V_{GS} = 10$ V  | 35                     |
|              | 0.030 at $V_{GS} = 4.5$ V | 30                     |

### FEATURES

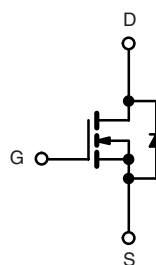
- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature



Available  
**RoHS\***  
 COMPLIANT



Drain Connected to Tab



N-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

| Parameter                                               |                | Symbol         | Limit          | Unit |
|---------------------------------------------------------|----------------|----------------|----------------|------|
| Gate-Source Voltage                                     |                | $V_{GS}$       | $\pm 20$       | V    |
| Continuous Drain Current ( $T_J = 175$ °C) <sup>b</sup> | $T_C = 25$ °C  | $I_D$          | 35             | A    |
|                                                         | $T_C = 100$ °C |                | 28             |      |
| Pulsed Drain Current                                    |                | $I_{DM}$       | 100            |      |
| Continuous Source Current (Diode Conduction)            |                | $I_S$          | 23             |      |
| Avalanche Current                                       |                | $I_{AS}$       | 20             | mJ   |
| Single Avalanche Energy (Duty Cycle $\leq 1$ %)         | $L = 0.1$ mH   | $E_{AS}$       | 20             |      |
| Maximum Power Dissipation                               | $T_C = 25$ °C  | $P_D$          | 100            | W    |
|                                                         | $T_A = 25$ °C  |                | 3 <sup>a</sup> |      |
| Operating Junction and Storage Temperature Range        |                | $T_J, T_{stg}$ | - 55 to 175    | °C   |

### THERMAL RESISTANCE RATINGS

| Parameter                                |                 | Symbol     | Typical | Maximum | Unit |
|------------------------------------------|-----------------|------------|---------|---------|------|
| Maximum Junction-to-Ambient <sup>a</sup> | $t \leq 10$ sec | $R_{thJA}$ | 18      | 22      | °C/W |
|                                          | Steady State    |            | 40      | 50      |      |
| Maximum Junction-to-Case                 |                 | $R_{thJC}$ | 3.2     | 4       |      |

Notes:

a. Surface Mounted on 1" x 1" FR4 board,  $t \leq 10$  sec.

| SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted            |               |                                                                                                                            |     |                  |           |               |
|---------------------------------------------------------------------------------------|---------------|----------------------------------------------------------------------------------------------------------------------------|-----|------------------|-----------|---------------|
| Parameter                                                                             | Symbol        | Test Conditions                                                                                                            | Min | Typ <sup>a</sup> | Max       | Unit          |
| Static                                                                                |               |                                                                                                                            |     |                  |           |               |
| Drain-Source Breakdown Voltage                                                        | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$                                                                        | 60  |                  |           | V             |
| Gate Threshold Voltage                                                                | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$                                                                            | 1.0 | 2.0              | 3.0       |               |
| Gate-Body Leakage                                                                     | $I_{GSS}$     | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$                                                                            |     |                  | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current                                                       | $I_{DSS}$     | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$                                                                                |     |                  | 1         | $\mu\text{A}$ |
|                                                                                       |               | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^{\circ}\text{C}$                                             |     |                  | 50        |               |
|                                                                                       |               | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}, T_J = 175\text{ }^{\circ}\text{C}$                                             |     |                  | 250       |               |
| On-State Drain Current <sup>b</sup>                                                   | $I_{D(on)}$   | $V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$                                                                                | 50  |                  |           | A             |
| Drain-Source On-State Resistance <sup>b</sup>                                         | $r_{DS(on)}$  | $V_{GS} = 10\text{ V}, I_D = 15\text{ A}$                                                                                  |     | 0.025            | 0.031     | $\Omega$      |
|                                                                                       |               | $V_{GS} = 10\text{ V}, I_D = 15\text{ A}, T_J = 125\text{ }^{\circ}\text{C}$                                               |     |                  | 0.055     |               |
|                                                                                       |               | $V_{GS} = 10\text{ V}, I_D = 15\text{ A}, T_J = 175\text{ }^{\circ}\text{C}$                                               |     |                  | 0.069     |               |
|                                                                                       |               | $V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$                                                                                 |     | 0.030            | 0.045     |               |
| Forward Transconductance <sup>b</sup>                                                 | $g_{fs}$      | $V_{DS} = 15\text{ V}, I_D = 15\text{ A}$                                                                                  |     | 20               |           | S             |
| Dynamic <sup>a</sup>                                                                  |               |                                                                                                                            |     |                  |           |               |
| Input Capacitance                                                                     | $C_{iss}$     | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                                              |     | 670              |           | pF            |
| Output Capacitance                                                                    | $C_{oss}$     |                                                                                                                            |     | 140              |           |               |
| Reverse Transfer Capacitance                                                          | $C_{rss}$     |                                                                                                                            |     | 60               |           |               |
| Total Gate Charge <sup>c</sup>                                                        | $Q_g$         | $V_{DS} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 23\text{ A}$                                                            |     | 11               | 17        | nC            |
| Gate-Source Charge <sup>c</sup>                                                       | $Q_{gs}$      |                                                                                                                            |     | 3                |           |               |
| Gate-Drain Charge <sup>c</sup>                                                        | $Q_{gd}$      |                                                                                                                            |     | 3                |           |               |
| Turn-On Delay Time <sup>c</sup>                                                       | $t_{d(on)}$   | $V_{DD} = 30\text{ V}, R_L = 1.3\text{ }\Omega$<br>$I_D \cong 23\text{ A}, V_{GEN} = 10\text{ V}, R_g = 2.5\text{ }\Omega$ |     | 8                | 15        | ns            |
| Rise Time <sup>c</sup>                                                                | $t_r$         |                                                                                                                            |     | 15               | 25        |               |
| Turn-Off Delay Time <sup>c</sup>                                                      | $t_{d(off)}$  |                                                                                                                            |     | 30               | 45        |               |
| Fall Time <sup>c</sup>                                                                | $t_f$         |                                                                                                                            |     | 25               | 40        |               |
| Source-Drain Diode Ratings and Characteristics ( $T_C = 25\text{ }^{\circ}\text{C}$ ) |               |                                                                                                                            |     |                  |           |               |
| Pulsed Current                                                                        | $I_{SM}$      |                                                                                                                            |     |                  | 50        | A             |
| Diode Forward Voltage                                                                 | $V_{SD}$      | $I_F = 15\text{ A}, V_{GS} = 0\text{ V}$                                                                                   |     | 1.0              | 1.5       | V             |
| Reverse Recovery Time                                                                 | $t_{rr}$      | $I_F = 15\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$                                                                      |     | 30               | 60        | ns            |

Notes:

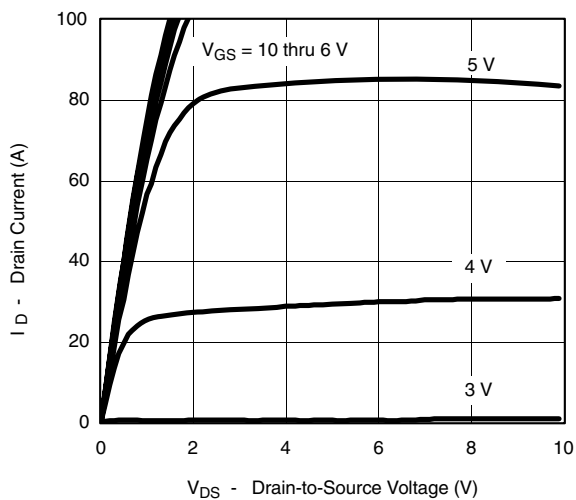
a. For design aid only; not subject to production testing.

b. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

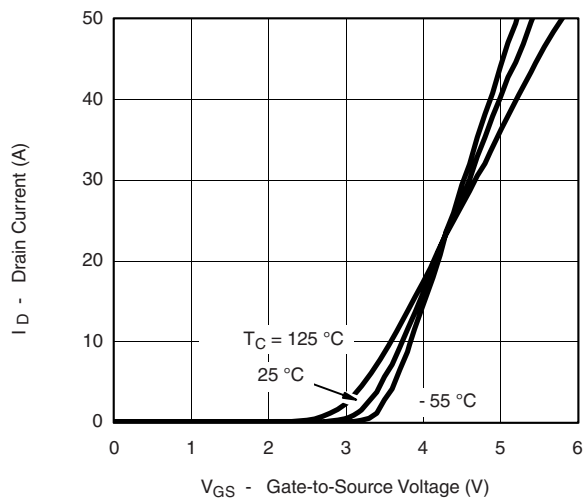
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

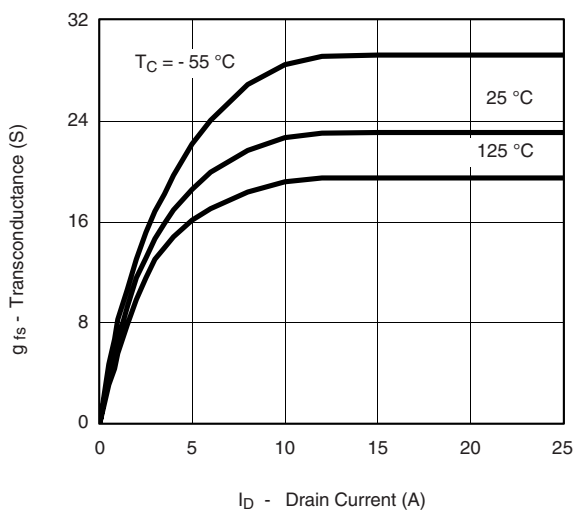
## TYPICAL CHARACTERISTICS 25 °C unless noted



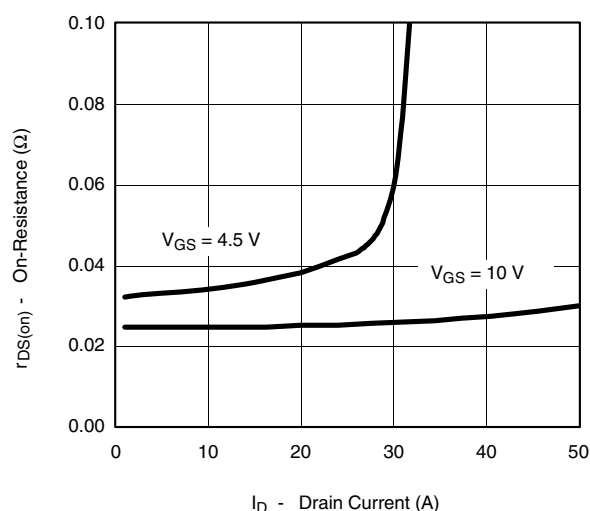
Output Characteristics



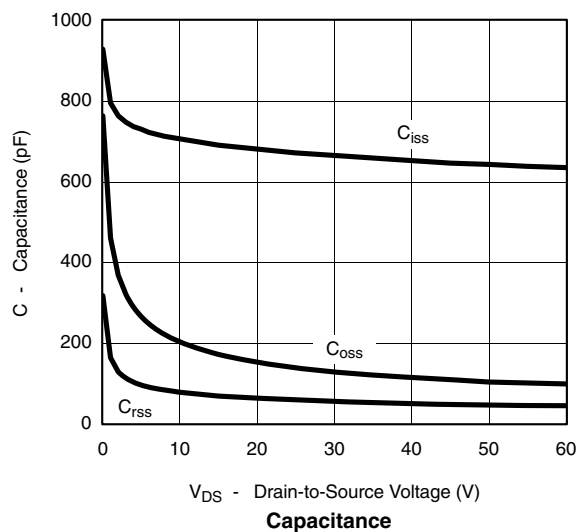
Transfer Characteristics



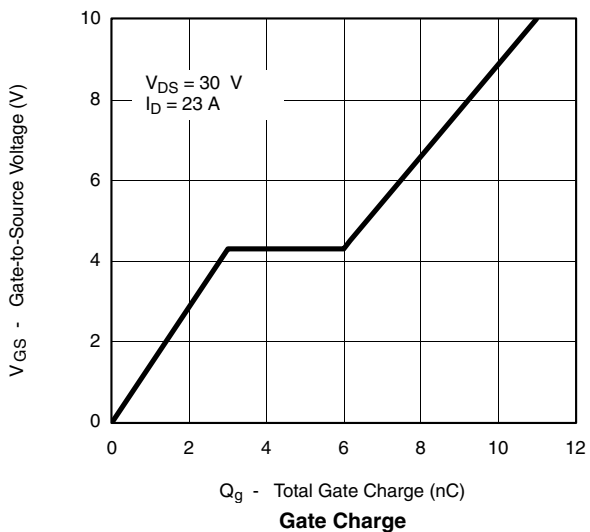
Transconductance



On-Resistance vs. Drain Current

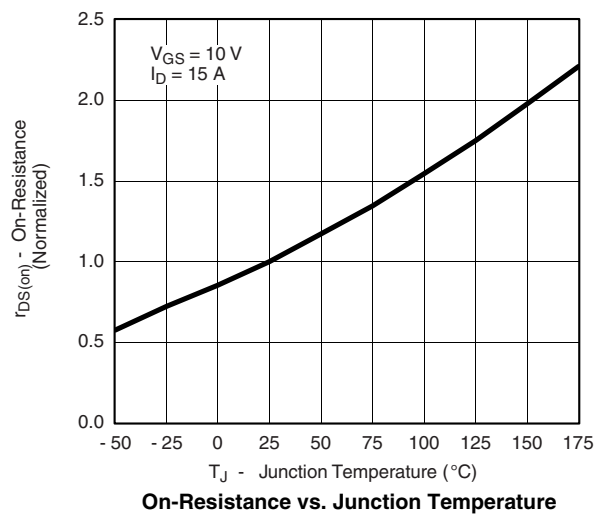
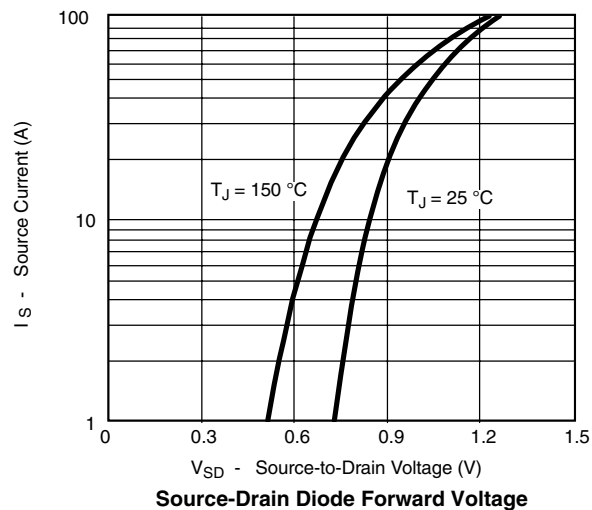


Capacitance

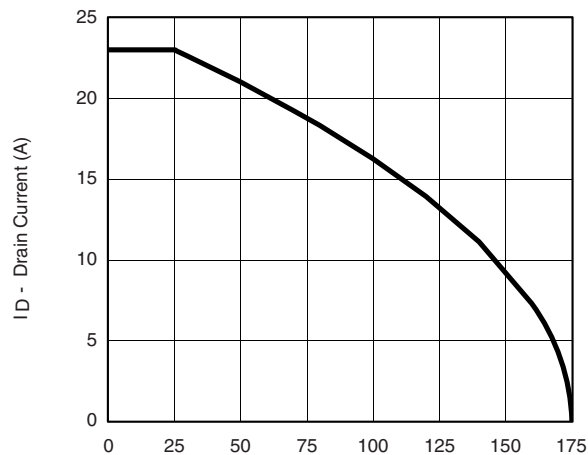


Gate Charge

## TYPICAL CHARACTERISTICS 25 °C unless noted

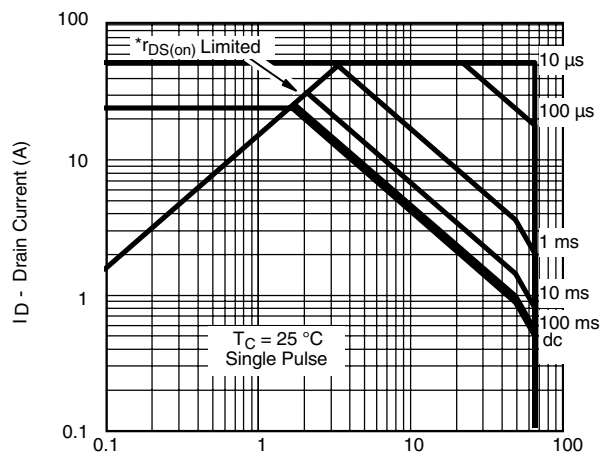


## THERMAL RATINGS



$T_A$  - Ambient Temperature (°C)

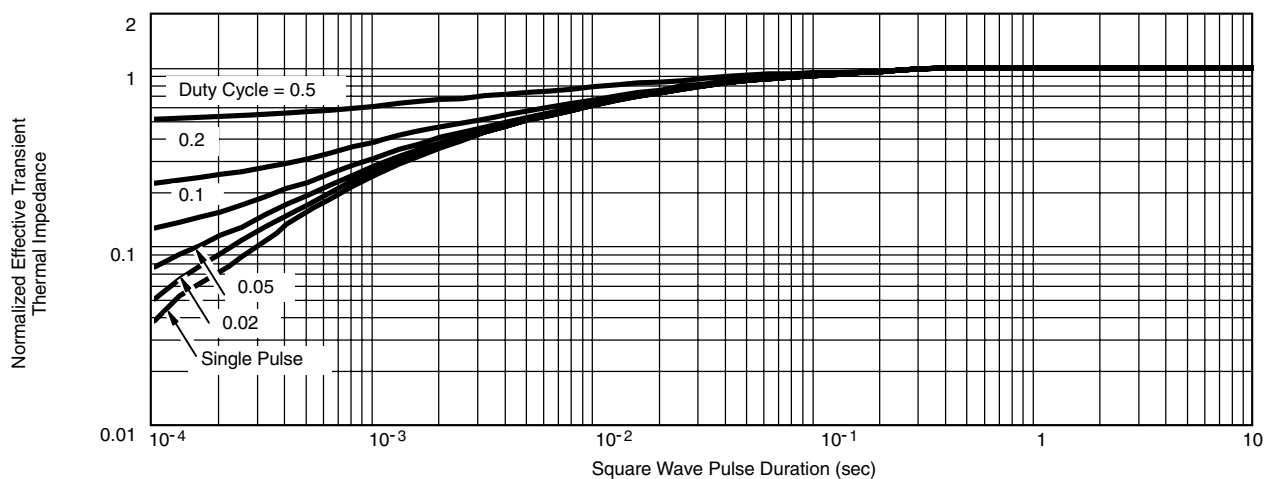
**Maximum Drain Current  
vs. Ambient Temperature**



$V_{DS}$  - Drain-to-Source Voltage (V)

\* $V_{GS}$  > minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

**Safe Operating Area**



**Normalized Thermal Transient Impedance, Junction-to-Case**

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